APPLICATION DATA SHEET

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Title of Invention

[MULTI-CHIP PACKAGE]

Application Type : regular, utility
Attorney Docket Number : 11238-US-PA

Request Not To Publish

I/We hereby request that the attached application not be published under 37 U.S.C. 122(b).

I/We hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing.

Correspondence address:

Customer Number: 31561

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Inventors Information:

Inventor 1:

Applicant Authority Type: Inventor Citizenship: TW Name prefix: Mr. Given Name: Moriss

Family Name: Kung

Residence:

City of Residence: Taipei Hsien

Country of Residence: TW

Address-1 of Mailing Address: c/o 8F, No. 533, Chung-Cheng Rd.,

Address-2 of Mailing Address: Hsin-Tien City

City of Mailing Address: Taipei Hsien

State of Mailing Address:

Postal Code of Mailing Address:

Country of Mailing Address: TW

Phone:	
Fax:	
E-mail:	
Inventor 2:	
Applicant Authority Type:	Inventor
Citizenship:	TW
Name prefix:	Mr.
Given Name:	Kwun-Yao
Family Name:	Но
Residence:	
City of Residence:	Taipei Hsien
Country of Residence:	TW
Address-1 of Mailing Address:	c/o 8F, No. 533, Chung-Cheng Rd.,
Address-2 of Mailing Address:	Hsin-Tien City
City of Mailing Address:	Taipei Hsien
State of Mailing Address:	
Postal Code of Mailing Address:	
Country of Mailing Address:	TW
Phone:	
Fax:	
E-mail:	

Attorney Information:

practitioner(s) at Customer Number:

31561



as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.